

*Sub
C
cancel*

an electronic device for suppressing article for use with an electronic device for suppressing electromagnetic interference of said device due to external and/or internal presence of electromagnetic waves, said body being comprised of soft magnetic powder dispersed through an organic binding agent and also including a heat conductive powder dispersed therethrough for improving the thermal conductivity of said electromagnetic interference suppressing body during use thereof in association with said electronic device.

*B1
cancel*

11. The composite magnetic body of claim 10, wherein said heat conductive powder is

500 >

at least one selected from the group consisting of alumina (Al_2O_3), aluminum nitride (AlN), cubic boron nitride (BN) and silicon carbide (Sic).

cancel

12. The composite magnetic body of claim 11 characterized in that said organic binding agent is a thermoplastic resin having a glass transition temperature of not less than about 120°C.

500 >

13. The composite magnetic body as in claim 12, wherein said organic binding agent is at least one of thermoplastic polyimide and a liquid crystal polymer.

Sub J2 >

14. An electromagnetic interference suppressing body as in any one of claims 10 to 13 in the form of sheets for use in contact with said electronic device to control the temperature thereof during use of said device.

R E M A R K S

Claims 10-14 are in the case for further prosecution.